

QUALITY MANAGEMENT ISO 9001

Code: TD_EGGER_HDF_Profile_EN

Revision: 01

Date: 18.11.2020

Technical data sheet

Egger HDF Profiles

Application area

Takeover of functional-conditioned building joints as well as to set clean and impact resistant transitions into the flooring

Material data

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Parameter	Unit				
Surface		Melamin-/ urea impregnated decor paper with AC4 lacquering			
Carrier material		HDF (high density fibreboard)			
Product		EGGER HDF end profile typ 6163:	EGGER HDF transition profile typ 6161:	EGGER HDF levelling profile typ 6162:	
Profile drawing		32.5	44	43.4	
Length	mm	2400	2400	2400	
Thickness	mm	33	44	44	
Width	mm	12	10	12	
Colour		individual			
Paintable		no			
Installation for flooring with a thickness of	mm	7 – 14			
Skirting per package	piece	12	10	10	
Meter per package	m	28,8	24	24	
Weight per piece	kg	0,46	0,5	0,58	
Weight per Box	kg	5,52	5,00	5,80	
Installation	Recommendation	Art. No.: 1131336 Application area: 8-10 mm Size: 2.400 x 10 x 7 mm [Lx Material: PVC Packaging unit: 1 PU = 10 p Weight: 1 PU = 1 kg	Application Size: 2.400 Material: P Packaging Weight: 1 F	Art. No.: 1448024 Application area: 10-14 mm Size: 2.400 x 10 x 10 mm [LxWxH] Material: PVC Packaging unit: 1 PU = 10 pce. Weight: 1 PU = 1,1 kg	
	Alternative	Gluing with 1-C PUR,- or SI adhesive	MP mounting Gluing with adhesive	n 1-C PUR,- or SMP mounting	



Flooring Profiles (HDF)

Parameter	Profile	Test method	
Formaldehyde Emission	E 1	EN 120	
Light resistance	level 7	EN 20105	
Recycling	recyclable		
Disposal	in burning plant /incinevator		
Storage	Standing or lying on an even base. Protect it from direct sunlight and moisture Climatic conditions : tempature 18°C, humidity {	55-70%	

The tolerance for cross section mass, longitudinal dimensions as well as distortion and bend corresponds RAL-RG 432.

We confirm that in the manufacturing process, in the semi-finished goods and in the profiles' itself no top coating, no paints, no lacquers and no adhesives with organic solvents, biocides and free formaldehyde are used and contained.